5-2364427-3 ✔ ACTIVE

TE Internal #: 5-2364427-3

Board-to-Board, 98 Position, 1 mm [.04 in] Centerline, Vertical, Black, 11.25 mm [.44 in] Height, 8.2 mm [.32 in] Width, PCI & PCI Express Connectors

View on TE.com >

Connectors > PCB Connectors > Card Edge Connectors > PCI & PCI Express Connectors



Connector System: **Board-to-Board**

Number of Positions: **98**

PCI Generation: **5**

Centerline (Pitch): **1 mm [.04 in]**

Termination Post & Tail Length: **1.1 mm [.043 in]**

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Connector System	Board-to-Board
Sealable	No

Configuration Features

Number of Positions	98
PCB Mount Orientation	Vertical
Ejector	Without

Body Features

Primary Product Color	Black

Contact Features

Contact Current Rating (Max)	1.1 A
Contact Mating Area Plating Material Thickness	.76 µm[30 µin]

Termination Features

Termination Method to PCB	Surface Mount

Termination Post & Tail Length	1.1 mm[.043 in]

Mechanical Attachment

Connector Mounting Type	Board Mount
PCB Mount Retention Type	Metal Hold-Down

Housing Features

Centerline (Pitch)	1 mm[.04 in]

Dimensions

Connector Height	11.25 mm[.44 in]
Connector Width	8.2 mm[.32 in]

Usage Conditions

Operating Temperature Range	-40 – 85 °C[-40 – 185 °F]

Operation/Application

Circuit Application	High Speed Data

Industry Standards

PCI Generation	5

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	有害物质含量符合标准要求 No Restricted Substance(s) Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JUNE 2025 (250) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these

limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

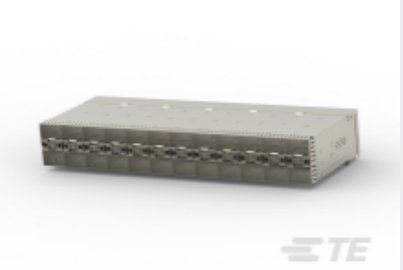


TE Part # 1-2364427-3
PCIE G5 CON,SMT,98P,15",WO MYLAR,HT

Customers Also Bought



TE Part #2041517-1
MINI USB, RCPT,V/T,DIP, B TYPE,30u" Au



TE Part #2227838-7
2X12 ZSFP+ CONNECTOR ASSEMBLY

Documents

Product Drawings

PCIE GEN5 CON,SMT,98P,30u Au,MYLAR,HT

English

CAD Files

Customer View Model

ENG_CVM_CVM_5-2364427-3_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5-2364427-3_A.3d_stp.zip

English

Customer View Model

ENG_CVM_CVM_5-2364427-3_A.2d_dxf.zip

English

3D PDF

3D

By downloading the CAD file I accept and agree to the Terms and Conditions of use.

Product Specifications

Application Specification

English